Designer's™ Data Sheet

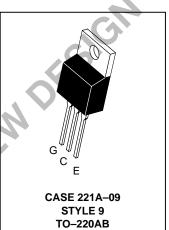
Insulated Gate Bipolar Transistor with Anti-Parallel Diode N-Channel Enhancement-Mode Silicon Gate

This Insulated Gate Bipolar Transistor (IGBT) is co-packaged with a soft recovery ultra-fast rectifier and uses an advanced termination scheme to provide an enhanced and reliable high voltage-blocking capability. Its new 600 V IGBT technology is specifically suited for applications requiring both a high temperature short circuit capability and a low $V_{CE(on)}$. It also provides fast switching characteristics and results in efficient operation at high frequencies. Co-packaged IGBTs save space, reduce assembly time and cost. This new E-series introduces an energy efficient, ESD protected and short circuit rugged device.

- Industry Standard TO–220 Package
- High Speed: E_{off} = 60 μJ/A typical at 125°C
- High Voltage Short Circuit Capability 10 μs minimum at 125°C, 400 V
- Low On–Voltage 2.0 V typical at 3.0 A, 125°C
- Soft Recovery Free Wheeling Diode
 is Included in the Package
- Robust High Voltage Termination
- ESD Protection Gate-Emitter Zener Diodes



IGBT & DIODE IN TO-220 4.0 A @ 90°C 6.0 A @ 25°C 600 VOLTS SHORT CIRCUIT RATED LOW ON-VOLTAGE



MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit Vdc	
Collector–Emitter Voltage	V _{CES}	600		
Collector–Gate Voltage ($R_{GE} = 1.0 \text{ M}\Omega$)	V _{CGR}	600	Vdc	
Gate-Emitter Voltage — Continuous	V _{GE}	±20	Vdc	
Collector Current — Continuous @ $T_C = 25^{\circ}C$ — Continuous @ $T_C = 90^{\circ}C$ — Repetitive Pulsed Current (1)	I _{C25} I _{C90} I _{CM}	6.0 4.0 8.0	Adc Apk	
Total Power Dissipation @ T _C = 25°C Derate above 25°C	P _D	62.5 0.51	Watts W/°C	
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to 150	°C	
Short Circuit Withstand Time (V_{CC} = 400 Vdc, V_{GE} = 15 Vdc, T_J = 125°C, R_G = 20 Ω)	t _{sc}	10	μs	
Thermal Resistance — Junction to Case – IGBT — Junction to Case – Diode — Junction to Ambient	R _{θJC} R _{θJC} R _{θJA}	2.0 3.6 65	°C/W	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	TL	260	°C	
Mounting Torque, 6–32 or M3 screw	10 lbf•in (1.13 N•m)			

(1) Pulse width is limited by maximum junction temperature. Repetitive rating.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

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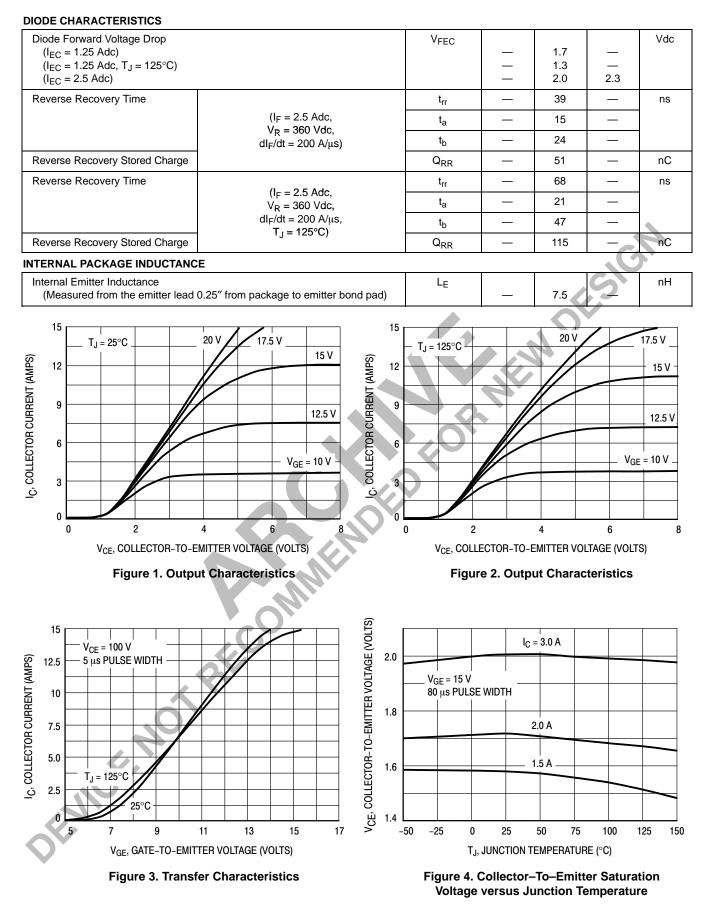


REV 2

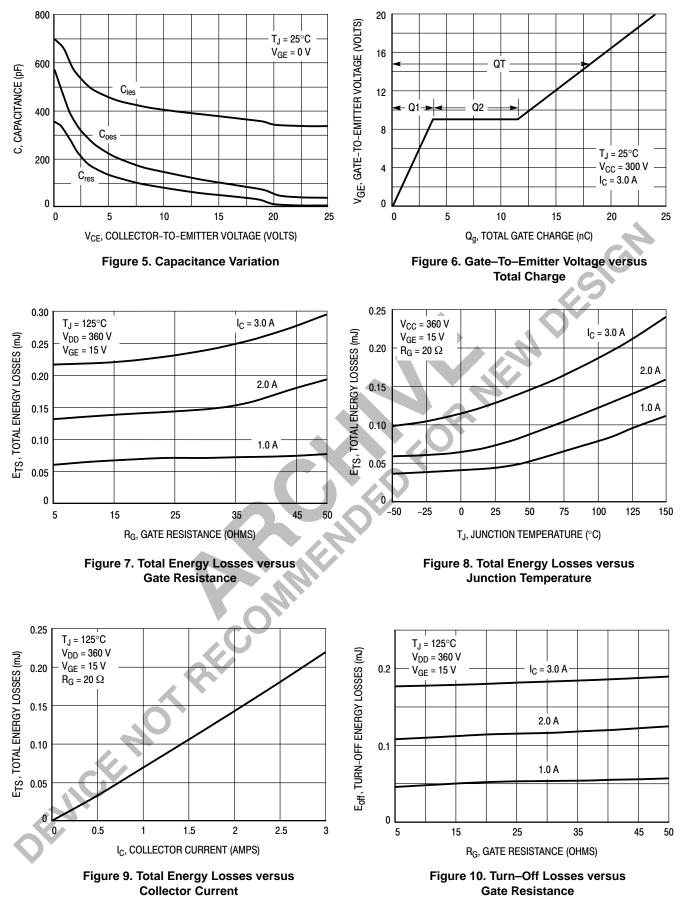
ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

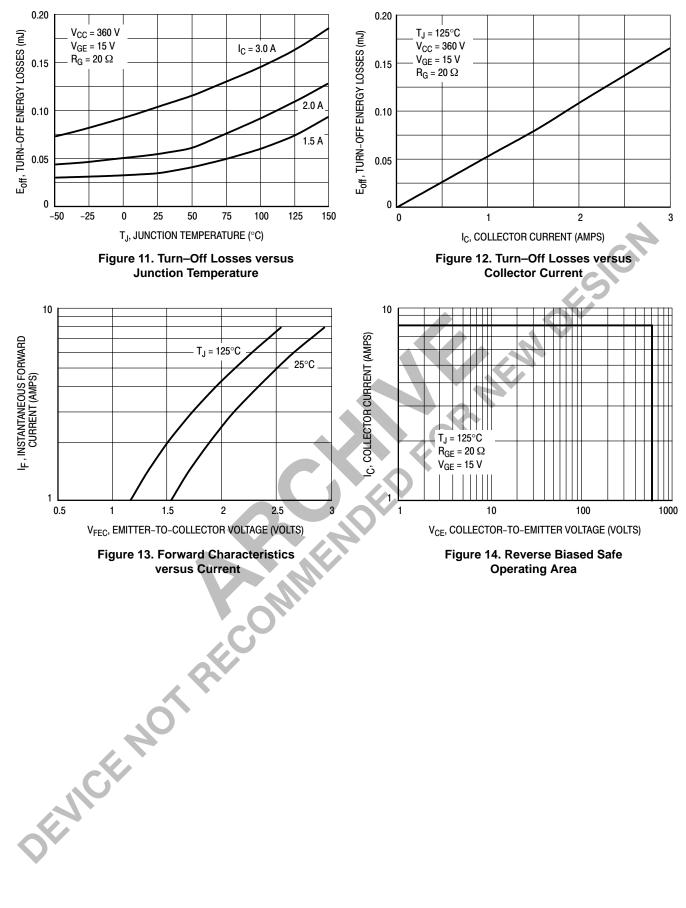
Cha	racteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector-to-Emitter Breakdown V ($V_{GE} = 0$ Vdc, $I_C = 25 \mu$ Adc) Temperature Coefficient (Positive	0	V _(BR) CES	600 —	 870		Vdc mV/°C
Zero Gate Voltage Collector Currer ($V_{CE} = 600 \text{ Vdc}, V_{GE} = 0 \text{ Vdc}$) ($V_{CE} = 600 \text{ Vdc}, V_{GE} = 0 \text{ Vdc}, T_{CE}$		ICES			10 200	μAdc
Gate–Body Leakage Current (V _{GE}	= ± 20 Vdc, V _{CE} = 0 Vdc)	I _{GES}	—	_	50	μAdc
ON CHARACTERISTICS (1)						
$\label{eq:constraint} \begin{array}{l} \mbox{Collector-to-Emitter On-State Volt} \\ (V_{GE}=15 \mbox{ Vdc}, \mbox{ I}_{C}=1.5 \mbox{ Adc}) \\ (V_{GE}=15 \mbox{ Vdc}, \mbox{ I}_{C}=1.5 \mbox{ Adc}, \mbox{ T}_{J}=0.5 \mbox{ Vdc}, \mbox{ I}_{C}=3.0 \mbox{ Adc}) \end{array}$	5	V _{CE(on)}		1.6 1.5 2.0	1.9 2.4	Vdc
Gate Threshold Voltage ($V_{CE} = V_{GE}$, $I_C = 1.0$ mAdc) Threshold Temperature Coefficie	nt (Negative)	V _{GE(th)}	4.0	6.0 10	8.0	Vdc mV/°C
Forward Transconductance (V _{CE} =	10 Vdc, I _C = 3.0 Adc)	9 _{fe}	—	1.8	_	Mhos
DYNAMIC CHARACTERISTICS						
Input Capacitance		C _{ies}	-	342	_	pF
Output Capacitance	(V _{CE} = 25 Vdc, V _{GE} = 0 Vdc, f = 1.0 MHz)	C _{oes}	×	40	_	
Transfer Capacitance		Cres		3.0	_	1
SWITCHING CHARACTERISTICS (1)				_	
Turn–On Delay Time		t _{d(on)}	—	34	_	ns
Rise Time		t _r	—	30	_]
Turn–Off Delay Time	$(V_{CC} = 360 \text{ Vdc}, I_C = 3.0 \text{ Adc},$	t _{d(off)}	—	36	_	
Fall Time	$V_{GE} = 15 \text{ Vdc}, \text{ L} = 300 \mu\text{H}, \\ \text{R}_{G} = 20 \Omega\text{)}$	t _f	—	216	_	1
Turn–Off Switching Loss	Energy losses include "tail"	E _{off}	—	100	150	μJ
Turn–On Switching Loss		E _{on}	—	25	_	
Total Switching Loss		E _{ts}	—	125		1
Turn-On Delay Time		t _{d(on)}	—	33		ns
Rise Time	(V _{CC} = 360 Vdc, I _C = 3.0 Adc,	t _r	—	32		
Turn–Off Delay Time		t _{d(off)}		56	_	1
Fall Time	V _{GE} = 15 Vdc, L = 300 μH, R _G = 20 Ω, T _J = 125°C)	t _f	_	340	_	1
Turn–Off Switching Loss	Energy losses include "tail"	E _{off}		170	—	μJ
Turn–On Switching Loss		E _{on}	—	50		1
Total Switching Loss		E _{ts}	_	220		1
Gate Charge		QT	—	18.1		nC
	(V _{CC} = 360 Vdc, I _C = 3.0 Adc, V _{GE} = 15 Vdc)	Q ₁	—	3.8		1
		Q ₂		7.8	_	1

(1) Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.

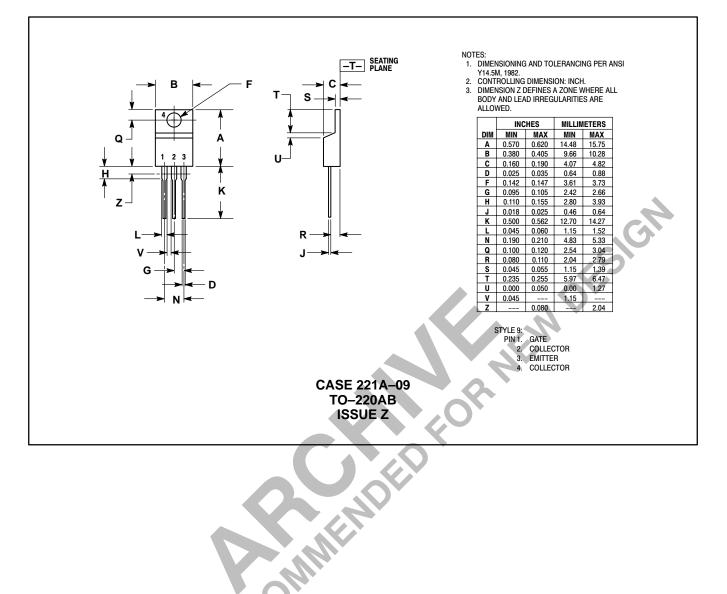


Motorola IGBT Device Data





PACKAGE DIMENSIONS



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